

Slovakia (SK) Coverage

Patent Office Details

Industrial Property Office of the Slovak Republic
ul. Jána Svermu 43
974 04 Banská Bystrica 4
The Slovak Republic

Web: <https://www.indprop.gov.sk/>

Official gazette: *Vestník UPV SR*

On 01.01.1993, the Czech and Slovak Federal Republic (CSFR) split into two separate nations: The Czech Republic and Slovakia. Under the Slovakian Constitution, all rights attaching under the laws of the former Czech and Slovak Federal Republic continue to apply in Slovakia

Kinds of Protection

Patents of Invention	Granted for a term of 20 years from submission date
Supplementary Protection Certificates	Extension of up to 5 years possible for medicinal products and plant protection products (plus possible final additional 6 extension period)
Utility Models	Protection for 4 years from date a filing, plus 2 further possible extensions of 3 years each
Industrial Designs and Models	May be registered

Convention & Treaty Membership

Patent Cooperation Treaty	01.01.1993
Signatory of:	Paris Convention (Stockholm wording) Budapest Treaty World Intellectual Property Organization International Convention for the Protection of New Varieties of Plants

Filing for Patents

Inventions that are new, involve an inventive step and have industrial application are patentable. Industrial production micro-organisms, and the biological processes and products obtained with their help are also patentable.

Applications may be made, in Slovak, by the inventor or his legal successor.

Under the *International Convention* applications claiming priority must be filed within 12 months of the earliest filing date in a Convention country. A certified copy of the basic application must be filed within three months of filing in Slovakia. A Slovak translation must be supplied if requested. Priority must be claimed at the time of filing.

Slovakia has a two-tiered examination system. The preliminary examination verifies that all application requirements have been met. Once the patent office is satisfied, the application is published. The full examination looks at the novelty and inventive step of the application. If the application complies with the requirements of patentability, the patent is granted. Full examination may be initiated at the request of the applicant or a third party. Requests for full examination must be made within 36 months from the application's filing date.

Applications are published 18 months after the filing, or if priority is claimed, the priority date, of the application. Following formal examination, the grant of a patent is announced in the official gazette. Publication of the application accords provisional protection.

Formal opposition procedures have been abolished by the New Act. However, third parties may file observations concerning the patentability of invention, after the application is published.

DWPI Coverage

Kind	DWPI Start Dates
A3 Patent application	7 July 1993
B6 Granted patent	8 December 1993

DWPI Data elements	Notes
✓ Bibliographic data	
✓ English value-add title and abstract	
✓ Manual Codes	Chemical (CPI) and Electrical (EPI) Update 1995/19 onwards

Numeration

Kind Code – A3

Publication Numbers			
Original Data	Derwent Innovation	Dialog	STN
Before 2000			
SKNnn-YY	SKYYYYNNNNN	SK YYNNNNN	SKYYNNNNN
SK4-98	SK199900004	SK 9900004	SK9900004
2000 onwards			
SKNnn-YYYY	SKYYYYNNNNN	SK YYYYNNNNN	SKYYYYnnnnnn
SK39-2010	SK201000109	SK 201000109	SK2010000109

YY or YYYY 2 or 4 digits representing the year
 Nnn 1 to 5 digit serial number
 NNNNN 5 digit serial number
 nnnnnn 6 digit serial number

Application Numbers*			
Original Data	Derwent Innovation	Dialog	STN
SKnn-YYYY	SKYYYYNnnA	SK YYYYNnn	SKYYYY-Nnn
SK25-2008	SK200825A	SK 200825	SK2008-25

YYYY 4 digit year
 Nnn 1 to 5 digit serial number
 nnnnnnn 7 digit serial number

**Full coverage of application numbers commenced from DWPI update 199216*

Kind Code – B6

Publication Numbers			
Original Data	Derwent Innovation	Dialog	STN
SKnnnnnn	SKnnnnnn	SK nnnnnn	SKnnnnnn
SK287751	SK287751	SK 287751	SK287751

nnnnnn 6 digit serial number